



Specification

COM35H3R25ULC

3.5" - 240 x 320 - SPI

Spec Revision: 2.0 Revision Date: 24.01.2025

Note: This specification is subject to change without prior notice

Specifications for

Blanview TFT-LCD Monitor

(3.5" QVGA 240 x RGB x 320 Portrait)

<u>A Sunlight readable TFT-LCD Monitor</u>

Version 2.0

(Please be sure to check the specifications latest version.)

MODEL COM35H3R25ULC

customer's Approval	
Signature :	
Name :	
Section :	
Title:	
Date :	

ORTUSTECH

Æ ¹	TC
-----	----

TOPPAN INC.

Electronics Division

Technological Development Department IV

Approved by

Checked by

Prepared by

Issue:Jan.29,2025

Version History

Ver.	Date	Page	Description		
0.0	Aug.24,2023	<u> </u>	_	Tentative issue	
1.0	Mar.15,2024	-	-	First issue	
\wedge		All		All	
×13			Change	Company name font	
		P.5		2.2 Display Method	
			Change	NTSC ratio	
		P.12		7.1.1 Display section	
			Add	Rating	
				7.1.2 Backlight section	
			Correct	Rating	
		P.13		7.2.1 3-wire serial interface timing characteristics	
			Correct	Symbol,Rating	
		P.14		7.2.2 4-wire serial interface timing characteristics	
			Correct	Symbol,Rating	
		P.20,21		9.1 Power ON Sequence	
		,	Correct	Positive gamma,Negative gamma	
		P.23,24		9.5 Refresh Sequence	
			Correct	Positive gamma,Negative gamma	
		P.27	0011000	11.1 Optical Characteristics	
			Add	Center Brightness	
		P.29	Add	12.1 Defective Display and Screen Quality	
			Add	Signal condition	
		P.31	Add	13. Reliability Test	
		F.31	Add	number of failures /number of examinations	
			Add	Surface discharge test(Non operation)Applied voltage	
2.0	Jan.29,2025	D 1		Cover	
2.0	Jan.29,2025		Add	Model specification	
<u></u> ★ ×6			Change	Department name	
<u> </u>		P.3	Change	Contents	
		1 .5	Add	Item	
		P.5	Auu	2.1 Features of the Product	
		F.J	Chango	Note	
		P.6	Change		
		P.0	Changa	<pre><features blanview="" of=""></features></pre>	
		P.27	Change	Content	
			A -I -I	11.2 About Sunlight readable	
			Add	Content	
				₹	



Contents

1.	Appli	cation	•••••	4
2.	Outli	ne Specifications		
	2.1	Features of the Product	• • • • • • • • • • • • • • • • • • • •	5
	2.2	Display Method	• • • • • • • • • • • • • • • • • • • •	5
3.	Dime	ensions and Shape		
	3.1	Dimensions	• • • • • • • • • • • • • • • • • • • •	7
	3.2	Outward Form	• • • • • • • • • • • • • • • • • • • •	8
	3.3	Serial Label (S-Label)	• • • • • • • • • •	9
4.	Pin A	Assignment	• • • • • • • • •	10
5.	Abso	lute Maximum Rating	• • • • • • • • •	11
6.	Reco	ommended Operating Conditions	• • • • • • • • • • • • • • • • • • • •	11
7.	Elect	rical Characteristics		
	7.1	DC Characteristics	• • • • • • • • • • • • • • • • • • • •	12
	7.2	AC Characteristics	• • • • • • • • • • • • • • • • • • • •	13
8.	Inter	face		
	8.1	Interface	• • • • • • • • • • • • • • • • • • • •	15
	8.2	Write protocol	• • • • • • • • • • • • • • • • • • • •	16
	8.3	Read protocol	• • • • • • • • • • • • • • • • • • • •	17
	8.4	Data transfer	• • • • • • • • • • • • • • • • • • • •	18
9.	Sequ	ience		
	9.1	Power ON Sequence	• • • • • • • • • • • • • • • • • • • •	20
	9.2	Sleep IN Sequence	• • • • • • • • • • • • • • • • • • • •	22
	9.3	Sleep OUT Sequence	• • • • • • • • • • • • • • • • • • • •	22
	9.4	Power OFF Sequence	• • • • • • • • • • • • • • • • • • • •	22
	9.5	Refresh Sequence	• • • • • • • • • • • • • • • • • • • •	23
	9.6	Power ON/OFF timing	• • • • • • • • • • • • • • • • • • • •	25
10.	LED	Circuit	• • • • • • • • • • • • • • • • • • • •	26
11.	Char	acteristics		
	11.1	Optical Characteristics	• • • • • • • •	27
	11.2	About Sunlight readable	• • • • • • • • •	27
	11.3	Temperature Characteristics	• • • • • • • •	28
12.	Crite	ria of Judgment		
	12.1	Defective Display and Screen Quality	• • • • • • • •	29
	12.2	Screen and Other Appearance	• • • • • • • •	30
13.	Relia	bility Test	• • • • • • • •	31
14.	Pack	ing Specifications	• • • • • • • • • • • • • • • • • • • •	33
15.	Hand	dling Instruction		
	15.1	Cautions for Handling LCD panels	• • • • • • • • • • • • • • • • • • • •	34
	15.2	Precautions for Handling	• • • • • • • • • • • • • • • • • • • •	35
	15.3	Precautions for Operation	• • • • • • • • • • • • • • • • • • • •	35
	15.4	Storage Condition for Shipping Cartons	• • • • • • • • • • • • • • • • • • • •	36
	15.5	Precautions for Peeling off		
		the Protective film	• • • • • • • • •	37
	15.6	Warranty	•••••	37
AF	PPEN	DIX		38

1. Application

This Specification is applicable to 89.4mm (3.5 inch) Blanview TFT-LCD monitor for non-military use.

- TOPPAN makes no warranty or assume no liability that use of this Product and/or any information including drawings in this Specification by Purchaser is not infringing any patent or other intellectual property rights owned by third parties, and TOPPAN shall not grant to Purchaser any right to use any patent or other intellectual property rights owned by third parties. Since this Specification contains TOPPAN's confidential information and copy right, Purchaser shall use them with high degree of care to prevent any unauthorized use, disclosure, duplication, publication or dissemination of TOPPAN's confidential information and copy right.
- If Purchaser intends to use this Products for an application which requires higher level of reliability
 and/or safety in functionality and/or accuracy such as transport equipment (aircraft, train, automobile, etc.),
 disaster-prevention/security equipment or various safety equipment,
 Purchaser shall consult TOPPAN on such use in advance.
- This Product shall not be used for application which requires extremely higher level of reliability and/or safety such as aerospace equipment, telecommunication equipment for trunk lines, control equipment for nuclear facilities or life-support medical equipment.
- It must be noted as an mechanical design manner, especial attention in housing design to prevent arcuation/flexure caused by stress to the LCD module shall be considered.
- TOPPAN assumes no liability for any damage resulting from misuse, abuse, and/or miss-operation of the Product deviating from the operating conditions and precautions described in the Specification.
- It shall be mutually conferred if nonconforming defect which result from unspecified cause in this specification arises.
- If any issue arises as to information provided in this Specification or any other information, TOPPAN and Purchaser shall discuss them in good faith and seek solution.
- TOPPAN assumes no liability for defects such as electrostatic discharge failure occurred during peeling off the protective film or Purchaser's assembly process.

Object substance	Maximum content [ppm]
Cadmium and its compound	100
Hexavalent Chromium Compound	1000
Lead & Lead compound	1000
Mercury & Mercury compound	1000
Polybrominated biphenyl series (PBB series)	1000
Polybrominated biphenyl ether series (PBDE series)	1000
Bis(2-ethylhexyl)phthalate series(DEHP series)	1000
Butyl benzyl phthalate series(BBP series)	1000
Dibutyl phthalate series(DBP series)	1000
Diisobutyl phthalate series(DIBP series)	1000

2. Outline Specifications



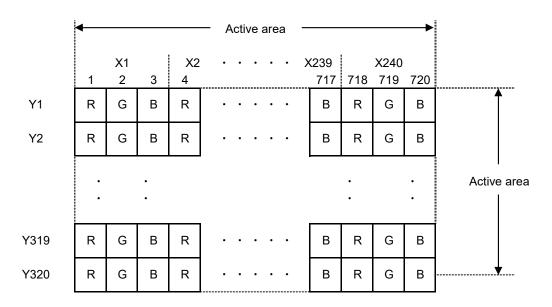
⚠ 2.1 Features of the Product

- 3.5 inch diagonal display, 720 [H] x 320 [V] dots. 240RGB x 320 pixel.
- 18-bit / 262,144 colors.
- Timing generator [TG], Counter-electrode driving circuitry, Built-in power supply circuit.
- Long life & High bright white LED back-light.
- Blanview TFT-LCD, improved outdoor visibility.

	Indoor			Out	door
	Readability	Power Efficiency (Battery Life)		Readability	Power Efficiency (Battery Life)
Transmissive	Good	Good		Average	Poor
Transflective	Average	Poor		Good	Good
Blanview	Good	Good		Excellent	Excellent

2.2 Display Method

Items	Specifications	Remarks
Display type VA type 262,144 colors		
	Blanview, Normally Black	
Driving method a-Si TFT Active matrix		
	Line-scanning, Non-interlace	
Dot arrangement	RGB stripe arrangement	Refer to "Dot arrangement"
Signal input method	3-wire, 4-wire serial interface	
Backlight type	Long life & High bright white LED	
NTSC ratio	65%	



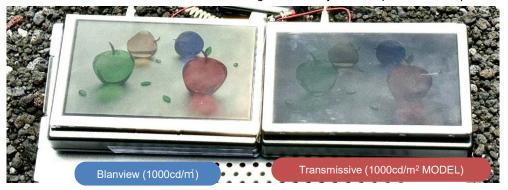
Dot arrangement (FPC cable placed left side)

/B\

<Features of Blanview>

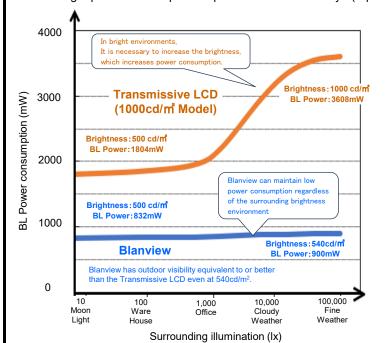
(A 7.0" WVGA display is shown as a typical sample)

Blanview is a TFT-LCD monitor that achieves sunlight readability with low power consumption.



*Display image comparison photo outdoors (at 100,000lx)

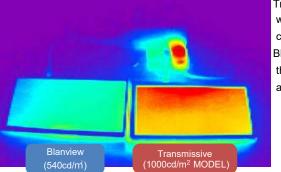
- * When compared at the same power consumption, Blanview's contrast at 100,000lx is more than two times higher than that of a transmissive LCD (1000cd/m² model). Blanview's contrast is 17.5, while that of a transmissive LCD is 7.5. Sunlight readability is Good with a contrast of 8 or higher on the TOPPAN index. (Contrast at 100,000lx is reference data.)
- Backlight power consumption required to assure visibility. (equivalent to 7.0"WVGA)



Sunlight Readable / BL Power comparison

	Sunlight Readable		BL Power	
Transmissive LCD (1000cd/㎡ Model)	Average		Poor	
Blanview	Excellent		Excellent	
		ĺ		

In bright environment, other companies' products require higher brightness, which increases power consumption, However TOPPAN' Blanview can maintain low power consumption without increasing brightness (visibility is not easily affected by the environment).



*Observation image with thermograph

Transmissive LCD (1000cd/m² MODEL) consume a lot of power, which places a large load on the customer's power circuit, causing problems such as heat generation.

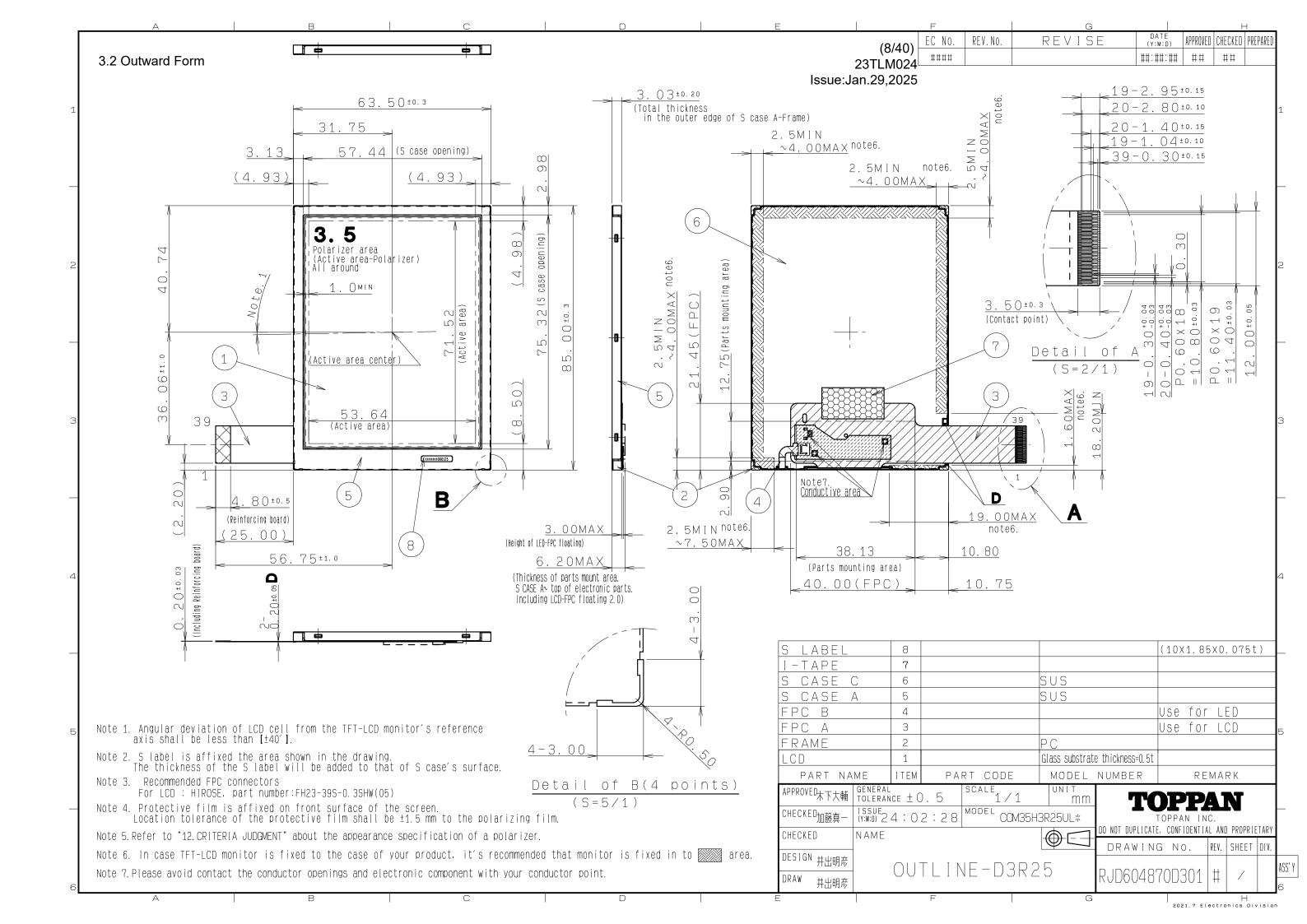
Blanview has low power consumption, so it places a low load on the customer's power supply circuit and does not cause any harmful effects such as heat generation.

Issue:Jan.29,2025

3. Dimensions and Shape

3.1 Dimensions

Items	Specifications	Unit	Remarks
Outline dimensions	63.5[H] × 85.0[V] × 3.03[D]	mm	exclude FPC and components on the FPC
Active area	53.64[H] × 71.52[V]	mm	89.40mm diagonal
Number of dots	720[H] × 320[V]	dot	
Dot pitch	74.5[H] × 223.5[V]	um	
Surface hardness of the	2	Н	
polarizer			
Weight	33.0	g	Include FPC cable



3.3 Serial Label (S-label)

3.3.1 Display items

S-label indicates the least significant digit of manufacture year (1digit), manufacture month with below alphabet (1letter), model code (5characters), serial number (6digits).

* Contents of Display

*	*	****	*****
-	_		
а	b	С	d

	Contents of display				
а	The least significant digit of manufacture year				
b	Manufacture month	Jan-A	May-E	Sep-I	
		Feb-B	Jun-F	Oct-J	
		Mar-C	Jul-G	Nov-K	
		Apr-D	Aug-H	Dec-L	
С	Model code	35SKC (Made in Japan)			
		35SLC (Made in Malaysia)			
d	Serial number				

^{*} Example of indication of Serial label (S-label)

· Made in Japan

3L35SKC000125

means "manufactured in December 2023, 3.5 inch, SK type, C specifications, serial number 000125"

· Made in Malaysia

3L35SLC000125

means "manufactured in December 2023, 3.5 inch, SL type, C specifications, serial number 000125"

3.3.2 Location of Serial Label (S-label)

Refer to 3.2 "Outward Form".

4. Pin Assignment

No.	Symbol	Function
1	VSS	GND
2	VCI	Power supply for main circuit
3	IOVCC	Power supply for I/O circuit
4	TE	Tearing effect signal. If not used, please this pin open.
5	SDO	Serial interface output pin. If not used, please this pin open.
6	DB15	Parallel data input
7	DB14	Unused pin. Please fix to GND level.
8	DB13	
9	DB12	
10	DB11	
11	DB10	
12	DB9	
13	DB8	
14	DB7	
15	DB6	
16	DB5	
17	DB4	
18	DB3	
19	DB2	
20	DB1	
21	DB0	
22	VSS	GND
23	SDA	Serial interface data I/O.
24	RDX	Unused pin. Please fix to GND level.
25	WRX	Register selection signal (for 4-wire I/F). If not used, please fix to GND level.
26	TEST	Test pin. Please keep this pin open
27	DCX	Serial interface clock.
28	CSX	Chip selection signal (Lo : Select, Hi : Unselect)
29	RESX	Reset signal (Lo-active)
30	IM3	Interface mode setting pin. 3-wire serial I: IM[3:0]=0101
31	IM2	4-wire serial I : IM[3:0]=0110
32	IM1	3-wire serial Ⅱ: IM[3:0]=1101
33	IM0	4-wire serial II: IM[3:0]=1110
34	NC	Open
35	NC	Open
36	NC	Open
37	NC	Open
38	BLH	LED drive power source. (Anode side)
39	BLL	LED drive power source. (Cathode side)

Note:

- Recommended connector : Hirose FH23 series "FH23-39S-0.3SHW(05)"
- In the circuit design, the terminal array of connector for use with terminal sequence of the "3.2 Outward Form", please be sure to check.
 - If the array of the signal input to the product is different, it may cause a malfunction.
- FPC of the terminal has been decorated with gold-plated.

 Connector contact terminals is recommended the use of gold-plated products.

Issue:Jan.29,2025

5. Absolute Maximum Rating

VSS=0V

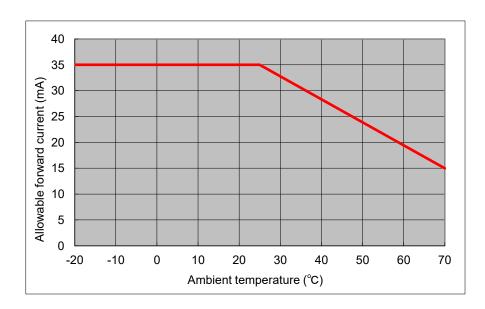
Item	Symbol	Condition	Ra	Rating		Applicable terminal
			MIN	MAX		
Supply voltage	VCI		-0.3	4.6	V	VCI
Supply voltage	IOVCC		-0.3	VCI	V	IOVCC
Input voltage for logic	VI	1	-0.3	IOVCC+0.3	V	SDA,RDX,WRX,DCX,CSX,
						RESX,IM[3:0]
LED Forward current	IL	Ta=25°C	_	35.0	mA	BLH - BLL
		Ta=70°C	_	15.0		
Storage temperature	Tstg		-30	80	$^{\circ}\!\mathbb{C}$	
range						
Storage atmospheric	Hstg	40°C90%RH c	40℃90%RH or less of moisture content			
range		with no conde	nsation			

6. Recommended Operating Conditions

VSS=0V

Item	Symbol	Condition		Rating		Unit	Applicable terminal
			MIN	TYP	MAX		
Supply voltage	VCI		2.8	3.3	3.6	V	VCI
Supply voltage	IOVCC		1.8	VCI	VCI	V	IOVCC
Input voltage for logic	VI		0	_	IOVCC	V	SDA,RDX,WRX,DCX,CSX,
							RESX,IM[3:0]
Operational	Тор	*note	-20	25	70	°C	LCD Panel surface
temperature range							temperature
Operating humidity	Нор	Ta≦40°C	20	=	85	%	
range		Ta> 40°C	40°C85%RH or less of moisture content with no condensation				

note: The maximum value of LED Forward current "IL", do not exceed the following allowable current value.



Issue:Jan.29,2025

7. Electrical Characteristics

7.1 DC Characteristics

7.1.1 Display section

(Unless otherwise noted, Ta=25°C,VCI=3.3V,IOVCC=3.3V,VSS=0V)

Item	Symbol	Condition		Rating	Unit	Applicable terminal	
			MIN	TYP	MAX		
Input Signal	VIH		0.7×IOVCC		IOVCC	V	SDA,RDX,WRX,DCX,CSX
Voltage	VIL		0		0.3×IOVCC	V	RESX,IM[3:0]
Output Signal	VOH	IOH = -0.1mA	0.8×IOVCC	_	_	V	TE,SDO,SDA
Voltage	VOL	IOL = 0.1mA	_	_	0.2×IOVCC	V	
Operating	ICI		_	7	14	mA	VCI
Current	IOICC	Color bar *note	_	3	10	uA	IOVCC
Standby	ICI		_	6	30	uA	VCI
Current	IOICC		_	2	10	uA	IOVCC

note: CPU is not accessing the display RAM, still image display state (Color bar display)

7.1.2 Backlight section

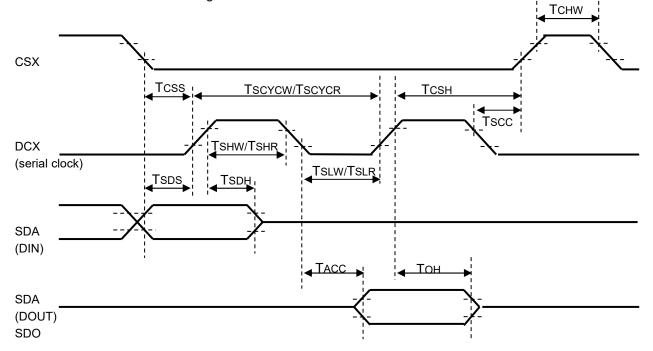
Item	Symbol	Condition		Rating			Applicable terminal
			MIN	TYP	MAX		
Forward	IL25	Ta=25℃	_	6.5	35.0	mA	BLH - BLL
current	IL70	Ta=70℃	_	_	15.0	mA	
Forward	VL	Ta=25°C, IL=6.5mA	_	15.87	16.42	V	
voltage							(Reference Value)
Estimated	LL	Ta=25°C, IL=6.5mA	_	50,000	_	hrs	
Life of LED		Note					

note:

- The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.
- This figure is given as a reference purpose only, and not as a guarantee.
- This figure is estimated for an LED operating alone.
 As the performance of an LED may differ when assembled as a monitor.
- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

7.2 AC Characteristics

7.2.1 3-wire serial interface timing characteristics

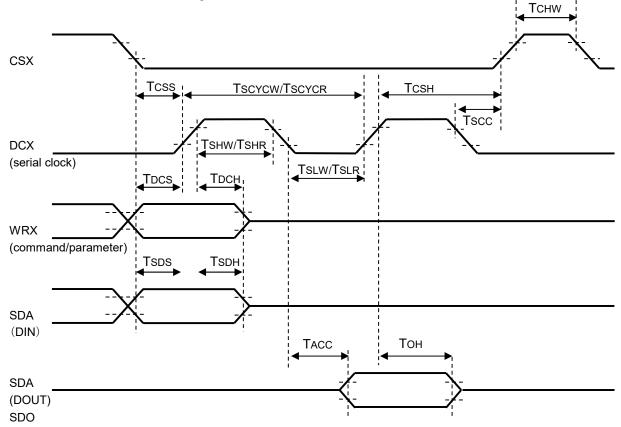


(Unless otherwise noted, Ta=25°C,VCI=3.3V,IOVCC=3.3V,VSS=0V)

Itam	Crimbal	Ra	ting	Linit	
Item	Symbol	MIN	MAX	Unit	
Chip Select Setup Time (Write)	TCSS	15		ns	CSX
Chip Select Hold Time (Write)	TCSH	15		ns	
Chip Select Setup Time (Read)	TCSS	60		ns	
Chip Select Hold Time (Read)	TSCC	65		ns	
Chip Select "H" Pulse Width (Write)	TCHW	40		ns	
Serial Clock Cycle (Write)	TSCYCW	50		ns	DCX
Serial Clock "H" Pulse Width (Write)	TSHW	7		ns	
Serial Clock "L" Pulse Width (Write)	TSLW	7		ns	
Serial Clock Cycle (Read)	TSCYCR	150		ns	
Serial Clock "H" Pulse Width (Read)	TSHR	60		ns	1
Serial Clock "L" Pulse Width (Read)	TSLR	60		ns	
Data Setup Time	TSDS	7		ns	SDA
Data Hold Time	TSDH	7		ns	
Access Time	TACC	10	50	ns	SDA(DOUT)/SDO
Output disable Time	ТОН	15	50	ns	
Input signal rise time	tr		15	ns	
Input signal fall time	tf		15	ns	

Note: All timing is defined as the reference to the 30-70% of IOVCC.

7.2.2 4-wire serial interface timing characteristics



(Unless otherwise noted, Ta=25°C, VCI=3,3V, IOVCC=3,3V, VSS=0V)

	(Unless	otnerwise r	noted, Ta=2	5°C,VCI=	=3.3V,IOVCC=3.3V,VSS=0V)
Item	Cymbol	Ra	ting	Unit	
iteiii	Symbol	MIN	MAX	Offic	
Chip Select Setup Time (Write)	TCSS	15		ns	CSX
Chip Select Hold Time (Write)	TCSH	15		ns	1
Chip Select Setup Time (Read)	TCSS	60		ns	1
Chip Select Hold Time (Read)	TSCC	65		ns	1
Chip Select "H" Pulse Width (Write)	TCHW	40		ns	1
Serial Clock Cycle (Write)	TSCYCW	50		ns	DCX
Serial Clock "H" Pulse Width (Write)	TSHW	7		ns	1
Serial Clock "L" Pulse Width (Write)	TSLW	7		ns	1
Serial Clock Cycle (Read)	TSCYCR	150		ns	1
Serial Clock "H" Pulse Width (Read)	TSHR	60		ns	1
Serial Clock "L" Pulse Width (Read)	TSLR	60		ns	1
D/CX Setup Time	TDCS	10		ns	WRX
D/CX Hold Time	TDCH	10		ns	1
Data Setup Time	TSDS	7		ns	SDA
Data Hold Time	TSDH	7		ns]
Access Time	TACC	10	50	ns	SDA(DOUT)/SDO
Output disable Time	ТОН	15	50	ns	
Input signal rise time	tr		15	ns	
Input signal fall time	tf		15	ns	1

Note: All timing is defined as the reference to the 30-70% of IOVCC.

8. Interface

8.1 Interface

IM3	IM2	IM1	IM0	Interface			
0	1	0	1	3-wire serial interface I			
0	1	1	0	4-wire serial interface I			
1	1	0	1	3-wire serial interface II			
1	1	1	0	4-wire serial interface II			

3-wire serial interface I

Pin Name	Description		
CSX	Chip selection signal		
DCX	Clock signal		
SDA Serial input/output data			

4-wire serial interface I

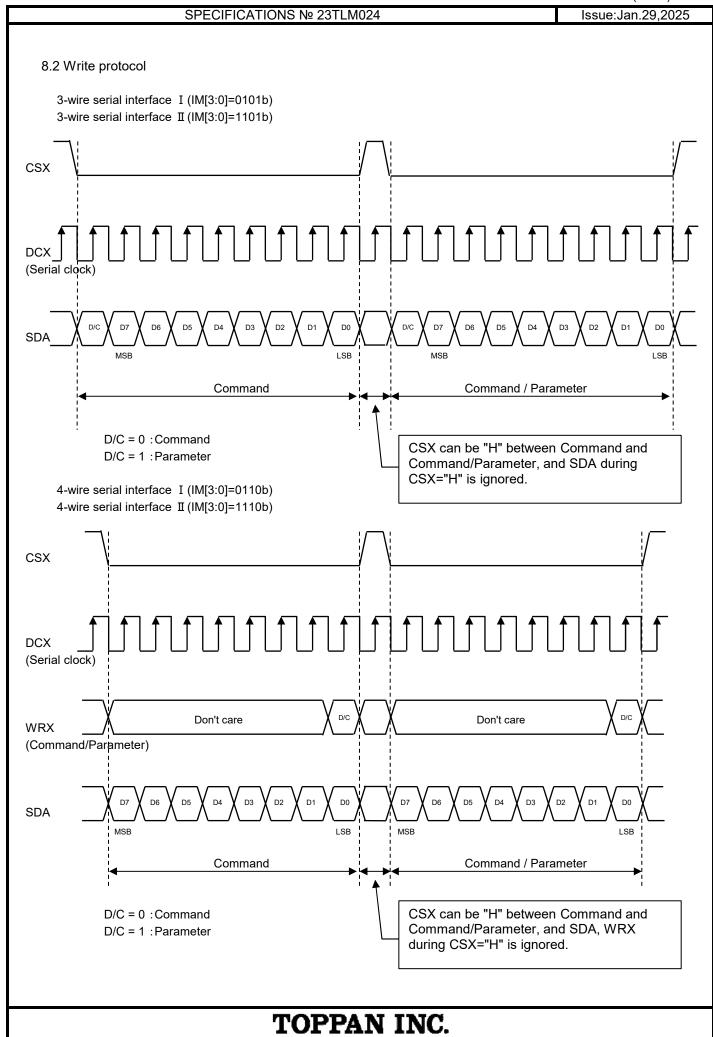
Pin Name	Description
CSX	Chip selection signal
WRX	WRX=Low :Command WRX=High : Parameter
DCX	Clock signal
SDA	Serial input/output data

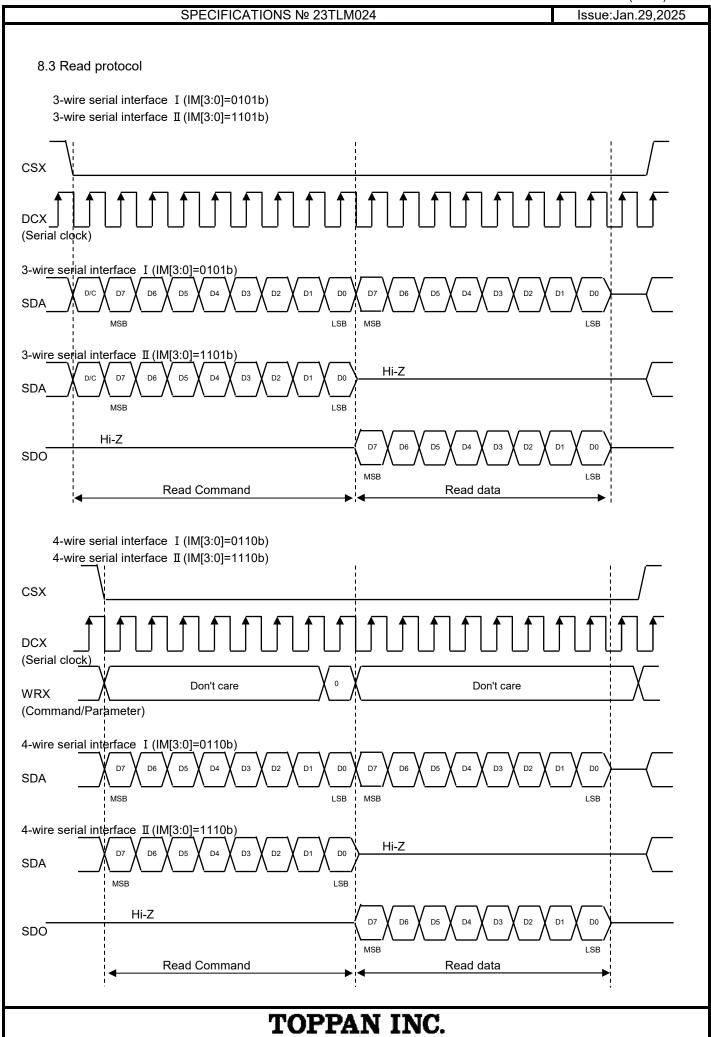
3-wire serial interface II

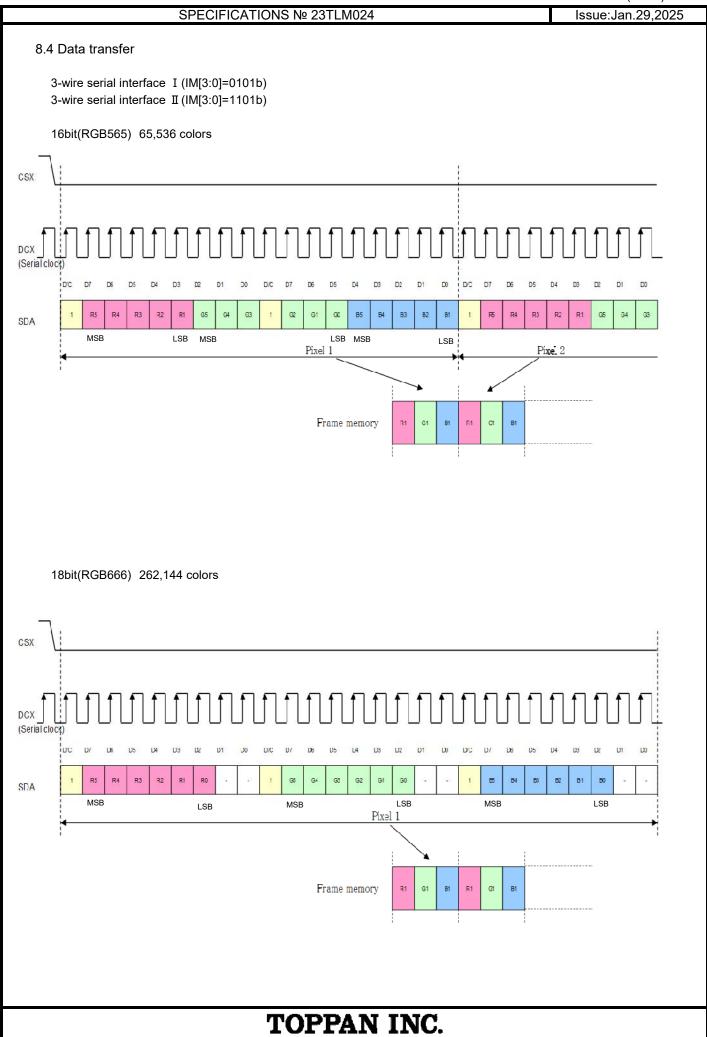
Pin Name	Description
CSX	Chip selection signal
DCX	Clock signal
SDA	Serial input data
SDO	Serial output data

4-wire serial interface II

Pin Name	Description
CSX	Chip selection signal
WRX	WRX=Low :Command WRX=High : Parameter
DCX	Clock signal
SDA	Serial input data
SDO	Serial output data







SPECIFICATIONS № 23TLM024 Issue:Jan.29,2025 4-wire serial interface I (IM[3:0]=0110b) 4-wire serial interface II (IM[3:0]=1110b) 16bit(RGB565) 65,536 colors CSX WRX (Command/Parameter) (Serial clock) C4 C3 C2 01 85 E3 123 C4 C3 C2 C1 CO R2 C5 00 BI R2 C5 LSB MSB MSB LSB MSB LSB Pixel 1 Pixel 2 Frame memory 18bit(RGB666) 262,144 colors CSX WRX (Command/Parameter) DCX (Serial clock) D7 D2 D4 D3 D7 D0 D7 D5 D0 D7 D2 D1 SDA LSB Pixe MSB LSB MSB MSB LSB В1 Frame memory G1 Б1 R1 G1 TOPPAN INC.

Issue:Jan.29,2025

9. Sequence

9.1 Power ON Sequence

(1/2)

9.	1 Power ON Sequence				(1/2)
No.			D/C	D[7:0]	Remarks
	VCI/IOVCC ON				
	RESX High	X Low			RESX High can be omitted
	RESX High → Low	∧ LUW			
	Wait 10 usec or more				
	$RESXLow \to High$				
	Wait 120 msec or more)			
1	Sleep Out		0	11 h	
	Wait 120 msec or more	;			
2	Memory access control		0	36 h	
	-	para 1	1	00 h	MX=MY=0
3	LCM Control	·	0	C0 h	
		para 1	1	3C h	XINV=XMV=XMX=XBGR=1
4	Pixel format	·	0	3A h	
		para 1	1	05 h	05h:65k,06h:262k
5	CMD2EN	·	0	DF h	
		para 1	1	5A h	
		para 2	<u>·</u> 1	69 h	
		para 3	<u>·</u> 1	02 h	
		para 4	1	01 h	Command2 enable
6	GATECTRL 1	F	0	E4 h	
	<i>5</i> , <u>2</u> 5 <u>1</u>	para 1	1	27 h	NL=320
		para 2	1	00 h	SCN=G0
		para 3	1	10 h	TMG=1,SM=GS=0
7	GATECTRL 2	para o	0	B7 h	1100 1,000 00
<i>'</i>	G/TEOTILE 2	para 1	1	75 h	VGH=14.9,VGL=-10.4
8	VCOMS setting	para 1	0	BB h	V G11= 14.0, V GE= 10.4
U	V OOIVIO SELLING	para 1	1	20 h	Δv=0.9typ
9	VAP/VAN signal	para i	0	D2 h	Δv=0.9typ
9	VAI / VAIN SIGIIAI	para 1	1	4C h	
10	VRH set	para i	0	C3 h	+
10	VIXITSEL	para 1	1	17 h	VAP=4.7+
11	Frame rate	para i	0	C6 h	VAI -4.71
' '	France rate	para 1	1	EF h	Column inversion,60Hz
12	Power control 1	para i	0	D0 h	Column inversion, our iz
12	Power control i	noro 1	1	A4 h	
		para 1			
40	Davis a sentral O	para 2	1	A1 h	
13	Power control 2	na== 4	0	E8 h	+
14	Docitivo games	para 1	0	83 h	+
14	Positive gamma	n 4		E0 h	
		para 1	1	A0 h	
		para 2	1	09 h	
		para 3	1	0E h	
		para 4	1	0B h	
		para 5	1	0C h	
		para 6	1	16 h	
		para 7	1	2F h	
		para 8	1	33 h	
		para 9	1	3F h	
		para 10	1	27 h	
		para 11	1	16 h	
		para 12	1	13 h	
		para 13	1	12 h	
		para 14	1	20 h	

			1	(2/2)
No.	111 11 12	D/C	D[7:0]	Remarks
45	Wait 10 msec or more		- 4.1	
15	Negative gamma	0	E1 h	
	para 1	1	F0 h	
	para 2	1	09 h	
	para 3	1	0F h	
	para 4	1	0C h	
	para 5	1	0C h	
	para 6	1	17 h	
	para 7	1	30 h	
	para 8	1	43 h	
	para 9	1	42 h	
	para 10	1	2A h	
	para 11	1	17 h	
	para 12	1	14 h	
	para 13	1	15 h	
	para 14	1	23 h	
4.0	Wait 10 msec or more		5 0.1	
16	Equalize control	0	E9 h	
	para 1	1	08 h	
	para 2	1	08 h	
47	para 3	1	00 h	
17	RGB interface control	0	B1 h	
	para 1	1	00 h	
	para 2	1	04 h	
40	para 3	1	14 h	
18	RAM Control	0	B0 h	lopus 4 6
	para 1	1	00 h	CPU interface
40	para 2	1	E0 h	
19	CA SET	0	2A h 00 h	V0[45:0]
	para 1	1		XS[15:8]
	para 2	1	00 h 00 h	XS[7:0]
	para 3			XE[15:8]
20	para 4	1	EF h	XE[7:0]
20	RA SET	1	2B h	V0[45.0]
	para 1	1	00 h 00 h	YS[15:8]
	para 2	1		YS[7:0] YE[15:8]
	para 3	1	01 h	
21	para 4	0	3F h B8 h	YE[7:0]
²	GT ADJ	1		+
	para 1		2A h	+
	para 2	1	2B h	+
	para 3		14 h	+
22	para 4	1	F5 h	+
22	Tearing Effect On	0	35 h	TEM = 0
23	para 1 RAMWR	0	00 h 2C h	TEM = 0
23		1	20 n **** h	urito data
	data 1	1	**** h	write data
	data 2	1	• • • • h	write data
<u> </u>			**** h	lumita data
<u> </u>	data n	1	n	write data
24	wait 10 msec or more		00 h	+
24	Display ON	0	29 h	+
05	wait 10 msec or more		ļ	
25	Backlight ON			

Issue:Jan.29,2025

9.2 Sleep IN Sequence

No.		D/C	D[7:0]	Remarks
1	Backlight OFF			
2	Display OFF	0	28 h	
	Wait 10 msec or more			
3	Sleep In	0	10 h	

9.3 Sleep OUT Sequence

No.		D/C	D[7:0]	Remarks
1	Sleep Out	0	11 h	
	Wait 120 msec or more			
2	Display ON	0	29 h	
	Wait 50 msec or more			
3	Backlight ON			

9.4 Power OFF Sequence

No.		D/C	D[7:0]	Remarks
1	Backlight OFF			
2	Display OFF	0	28 h	
	Wait 10 msec or more			
3	Sleep In	0	10 h	
	Wait 120 msec or more			
4	RESX High \rightarrow Low			
5	VCI/IOVCC OFF			

Issue:Jan.29,2025

9.5 Refresh Sequence

(1/2)

Sleep Out Wait 120 msec or more Memory access control para 1 LCM Control para 1 Pixel format para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 2	D/C 0 1 0 1 0 1 0 1 1 1 1	D[7:0] 11 h 36 h 00 h C0 h 3C h 3A h 05 h DF h 5A h 69 h 02 h 01 h	Remarks MX=MY=0 XINV=XMV=XMX=XBGR=1 05h:65k,06h:262k
Wait 120 msec or more Memory access control para 1 LCM Control para 1 Pixel format para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	0 1 0 1 0 1 0 1 1 1 1	36 h 00 h C0 h 3C h 3A h 05 h DF h 5A h 69 h 02 h	XINV=XMV=XMX=XBGR=1
Memory access control para 1 LCM Control para 1 Pixel format Para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	1 0 1 0 1 0 1 1 1 1	00 h C0 h 3C h 3A h 05 h DF h 5A h 69 h 02 h	XINV=XMV=XMX=XBGR=1
para 1 LCM Control para 1 Pixel format para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	1 0 1 0 1 0 1 1 1 1	00 h C0 h 3C h 3A h 05 h DF h 5A h 69 h 02 h	XINV=XMV=XMX=XBGR=1
LCM Control para 1 Pixel format para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	0 1 0 1 0 1 1 1	C0 h 3C h 3A h 05 h DF h 5A h 69 h 02 h	XINV=XMV=XMX=XBGR=1
para 1 Pixel format para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	1 0 1 0 1 1 1	3C h 3A h 05 h DF h 5A h 69 h	
Pixel format para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	0 1 0 1 1 1	3A h 05 h DF h 5A h 69 h 02 h	
para 1 CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	1 0 1 1 1	05 h DF h 5A h 69 h 02 h	05h:65k,06h:262k
CMD2EN para 1 para 2 para 3 para 4 GATECTRL 1 para 1	0 1 1 1	DF h 5A h 69 h 02 h	05h:65k,06h:262k
para 1 para 2 para 3 para 4 GATECTRL 1 para 1	1 1 1 1	5A h 69 h 02 h	
para 2 para 3 para 4 GATECTRL 1 para 1	1 1 1	69 h 02 h	
para 3 para 4 GATECTRL 1 para 1	1	02 h	
para 4 GATECTRL 1 para 1	1		
para 4 GATECTRL 1 para 1		01 h	
GATECTRL 1 para 1			Command2 enable
para 1	U	E4 h	
	1	27 h	NL=320
nara zi	<u>·</u> 1	00 h	SCN=G0
para 3	<u>·</u> 1	10 h	TMG=1,SM=GS=0
GATECTRL 2	0	B7 h	1,011 00 0
para 1	1	75 h	VGH=14.9,VGL=-10.4
-			V 311-14.0, V 32-10.4
~			Δv=0.9typ
-			Δν-0.9typ
-			
			VAD 47.
-			VAP=4.7+
			Column inversion,60Hz
·			
•			
para 1	1		
Positive gamma	0	E0 h	
	1		
para 2	1	09 h	
para 3	1	0E h	
para 4	1	0B h	
para 5	1	0C h	
para 6	1	16 h	
para 7	1	2F h	
para 8	1	33 h	
	1		
-			
		20 h	+
	VCOMS setting para 1 VAP/VAN signal para 1 VRH set para 1 Frame rate para 1 Power control 1 para 2 Power control 2 para 1 Positive gamma para 2 para 3 para 4 para 5 para 6 para 7	VCOMS setting 0 para 1 1 VAP/VAN signal 0 para 1 1 VRH set 0 para 1 1 Frame rate 0 para 1 1 Power control 1 0 para 2 1 Power control 2 0 para 1 1 Positive gamma 0 para 1 1 para 2 1 para 3 1 para 4 1 para 5 1 para 6 1 para 8 1 para 9 1 para 10 1 para 11 1 para 12 1 para 13 1	VCOMS setting 0 BB h para 1 1 20 h VAP/VAN signal 0 D2 h para 1 1 4C h VRH set 0 C3 h para 1 1 17 h Frame rate 0 C6 h para 1 1 EF h Power control 1 0 D0 h para 1 1 A4 h para 2 1 A1 h Power control 2 0 E8 h para 1 1 A0 h para 1 1 A0 h para 2 1 09 h para 3 1 0E h para 4 1 0B h para 5 1 0C h para 6 1 16 h para 7 1 2F h para 8 1 33 h para 9 1 3F h para 10 1 27 h para 12 1 13 h

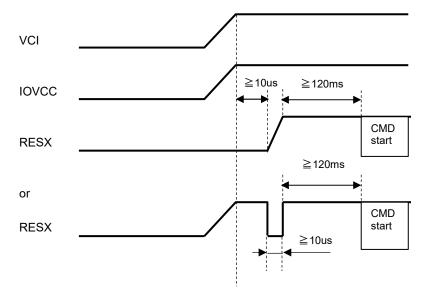
(2/2)

				(2/2)
No.		D/C	D[7:0]	Remarks
	Wait 10 msec or more			
15	Negative gamma	0	E1 h	
	para 1	11	F0 h	
	para 2	1	09 h	
	para 3	1	0F h	
	para 4	1	0C h	
	para 5	1	0C h	
	para 6	1	17 h	
	para 7	1	30 h	
	para 8	1	43 h	
	para 9	1	42 h	
	para 10	1	2A h	
	para 11	1	17 h	
	para 12	1	14 h	
	para 13	1	15 h	
	para 14	1	23 h	
	Wait 10 msec or more			
16	Equalize control	0	E9 h	
•	para 1	1	08 h	
•	para 2	1	08 h	
Ì	para 3	1	00 h	
17	RGB interface control	0	B1 h	
ľ	para 1	1	00 h	
•	para 2	1	04 h	
	para 3	1	14 h	
18	RAM Control	0	B0 h	
•	para 1	1	00 h	CPU interface
•	para 2	1	E0 h	
19	CA SET	0	2A h	
•	para 1	1	00 h	XS[15:8]
	para 2	1	00 h	XS[7:0]
i	para 3	1	00 h	XE[15:8]
	para 4	1	EF h	XE[7:0]
20	RA SET	0	2B h	
i	para 1	1	00 h	YS[15:8]
•	para 2	1	00 h	YS[7:0]
•	para 3	1	01 h	YE[15:8]
	para 4	1	3F h	YE[7:0]
21	GT ADJ	0	B8 h	
	para 1	1	2A h	†
	para 2	<u>.</u> 1	2B h	†
	para 3	1	14 h	<u> </u>
	para 4	1	F5 h	<u> </u>
22	Tearing Effect On	0	35 h	
	para 1	1	00 h	TEM = 0
23	RAMWR	0	2C h	I LIVI - U
20	data 1	1	**** h	write data
}	data 2	1 1	**** h	write data
	data 2		• • • • h	write uata
			**** h	urito doto
	data n	1	n	write data
0.4	wait 10 msec or more		20 F	+
24	Display ON	0	29 h	<u> </u>
i l	wait 10 msec or more			

9.6 Power ON/OFF timing

Power Supply ON Sequence

We recommend that you supplied at the same time VCI and IOVCC. However, there is no problem even if the supply IOVCC later than VCI. Please release the reset from at least 10us after each power supply.



Power Supply OFF Sequence

We recommend that you removed at the same time VCI and IOVCC. However, there is no problem even if IOVCC OFF faster than VCI.

11. Characteristics

11.1 Optical Characteristics

(Measurement Condition)

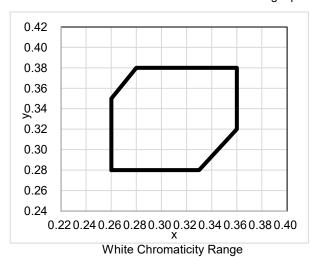
Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200 (OTSUKA ELECTRONICS), EZcontrastXL88 (ELDIM)

Driving condition: VCI=3.3V,IOVCC=3.3V, VSS=0V, Optimized VCOMDC

Backlight: IL= 6.5 mA
Measured temperature: Ta = 25°C

	Item	Symbol	Condition	MIN	TYP	MAX	Unit	Note №	Remark
se	Rise time	TON	[Data]=	-	-	100	ms	1	
Response time	+ Fall time	TOFF	00h← → 3Fh						
Contrast ratio	Backlight ON	CR	[Data]= 3Fh / 00h	480	800	-		2	
Con	Backlight OFF			-	3	-			
<u></u>	Left	θL	[Data]=	80	-	-	deg	3	
Viewing angle	Right	θR	3Fh / 00h	80	-	-	deg		
/iev	Up	φU		80	-	-	deg		
	Down	φD		80	-	-	deg		
White Chromaticity x			[Data]= 3Fh	White chromaticity range			4		
Center Brightness			[Data]= 3Fh	-	900	-	cd/m²	5	IL=20mA * Reference
				175	250	-			IL=6.5mA
Brightness distribution			[Data]= 3Fh	70	-	-	%	6	
Burn-in					rved afte	rn-in ima r 2 hours isplay.	_	7	

^{*} Note number 1 to 7: Refer to the APPENDIX of "Reference Method for Measuring Optical Characteristics and Performance".



(White Chromaticity Range)

Х	у
0.26	0.28
0.33	0.28
0.36	0.32
0.36	0.38
0.28	0.38
0.26	0.35

11.2 About Sunlight readable

Item	Illuminance	Display visibility	Remarks
Sunlight readable	100,000 lx	Possible	Refer to <features blanview="" of=""></features>

Issue:Jan.29,2025

11.3Temperature Characteristics

(Measurement Condition)

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200 (OTSUKA ELECTRONICS)

Driving condition: VCI=3.3V,IOVCC=3.3V, VSS=0V, Optimized VCOMDC

Backlight: IL= 6.5 mA

Item		Symbol	Specif	Remark	
			Ta = -20 °C	Ta = 70 °C	
Response time	Rise time + Fall time	TON + TOFF	1000 msec or less	80 msec or less	
Contrast ratio		CR	200 or more	200 or more	Backlight ON
Display Quality			No noticeable display defect or ununiformity should be observed.		

Issue:Jan.29,2025

12. Criteria of Judgment

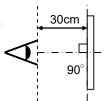
12.1 Defective Display and Screen Quality

Test Condition: Observed TFT-LCD monitor from front during operation with the following conditions

Driving Signal: Raster Patter (RGB, white, black) Signal condition: [Data]:00h, 25h, 3Fh (3steps)

Observation distance: 30 cm

Illuminance: 200 to 350 lx Backlight: IL=6.5mA



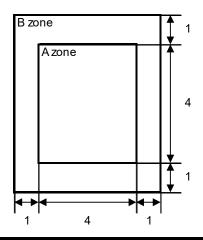
De	efect item	Defect content		Criteria
	Line defect	Black, white or c	olor line, 3 or more neighboring defective dots	Not exists
ality	Dot	_	ss on dot-by-dot base due to defective	Refer to table 1
ay Qu	Dot defect	(brighter dot, dar	,	
Displ		Low bright dot: \	/isible through 2% ND filter at [Data]=00h /isible through 5% ND filter at [Data]=00h r dark through white display at [Data]=25h	
			5% ND filter at [Data]=00h	Acceptable
	Stain	Uneven brightne	ss (white stain, black stain etc)	Invisible through 5% ND filter at Black screen. Invisible through 1% ND filter at other screen.
ΞĘ	Foreign	Point-like	0.25mm< φ	N=0
na	Foreign particle		0.20 mm< $\phi \leq 0.25$ mm	N≦2
n C			φ ≦0.20mm	Acceptable
Screen		Liner	3.0mm < L and 0.08mm < W	N=0
Sc			$L \le 3.0$ mm or $W \le 0.08$ mm	Acceptable
	Others			Use boundary sample
				for judgment when necessary

^{*} φ (mm): Average diameter = (major axis + minor axis) / 2, W (mm): Width, L (mm): Length, N: Permissible number

Table1

Area	High bright dot	Low bright dot	Dark dot	Total	Criteria
Α	0	2	2	3	Permissible distance between same color bright dots (includes neighboring dots): 3 mm or more
В	2	4	4	6	Permissible distance between same color high bright dots (includes neighboring dots): 5 mm or more
Total	2	4	4	7	

<Portrait model>



Division of A and B areas

B area: Active area

Dimensional ratio between A and B at

Dimensional ratio between A and B areas: 1: 4: 1

(Refer to the left figure)

Issue:Jan.29,2025

12.2 Screen and Other Appearance

Testing conditions

Observation distance: 30 cm

Illuminance: 1200 \sim 2000 lx

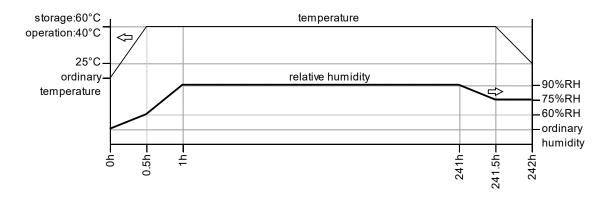
	Item	Criteria	Remark
	Flaw	Ignore invisible defect when the backlight is on.	Applicable area: Active area only
rizer	Stain		(Refer to the section 3.2 Outward Form)
	Dirt		
ola	Stain Dirt Bubble		
	Dust		
	Dent		
S	case	No functional defect occurs	
FF	PC .	No functional defect occurs	

SPECIFICATIONS № 23TLM024 Issue:Jan.29,2025

13. Reliability Test

	Test item	Test condition		number of failures /
				number of examinations
	High temperature storage	Ta = 80°C	240hrs	0/3
	Low temperature storage	Ta = -30°C	240hrs	0/3
	High temperature &	Ta = 60°C, RH = 90%,	240hrs	0/3
st	high humidity storage	non condensing	*	
Durability test	High temperature operation	Tp = 70°C	240hrs	0/3
l iii	Low temperature operation	Tp = -20°C	240hrs	0/3
ıra	High temperature &	Tp = 40°C, RH = 90%,	240hrs	0/3
△	high humidity operation	non condensing	*	
	Thermal shock storage	-30°C ↔ 80°C (30min / 30min)	100cycles	0/3
	Lightfastness	Xenon Blackpanel 63±3°C non-shower		0/3
		450W/m²(300~700nm) non-operating Integral dose 800MJ/m²		
	Electrostatic discharge test	Confirms to EIAJ ED-4701/300, C=200pF,R=0Ω,V=±200V		0/3
est	(Non operation)	Each 3 times of discharge on and	power supply	
<u>a</u>		and other terminals.		
ent	Surface discharge test	C=250pF, R=100Ω, V=±12kV		0/3
Ē	(Non operation)	Each 5 times of discharge in both polarities		
/io		on the center of screen with the ca	se grounded.	
en	Vibration test	Total amplitude 1.5mm, f=10 \sim 55 \vdash	łz,	0/3
g		X,Y,Z directions for each 2 hours		
anic	mpact test Use TOPPAN original jig (see next page) and		0/3	
Mechanical environmental test		make an impact with peak acceleration of 1000m/s ² for 6 msec		
ž		with half sine-curve at 3 times to each X, Y, Z directions		
		in conformance with JIS C 60068-2-27-2011.		
ס	Packing vibration-proof test	Acceleration of 19.6m/s ² with frequency of 10→55→10Hz,		0 / 1 packing
cking est		X,Y, Zdirection for each 30 minutes.		
Packing test	Packing drop test	Drop from 75cm high.		0 / 1 packing
		1 time to each 6 surfaces, 3 edges	, 1 corner	

% The profile of high temperature/humidity storage and High Temperature/humidity operation (Pure water of over 10M Ω ·cm shall be used.)



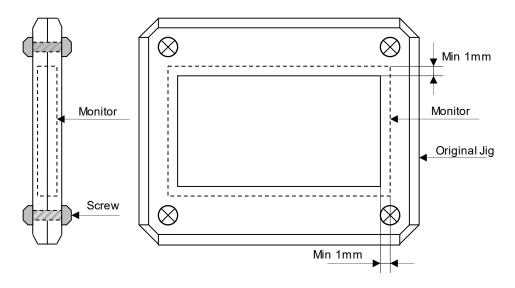
Issue:Jan.29,2025

Table2. Reliability Criteria

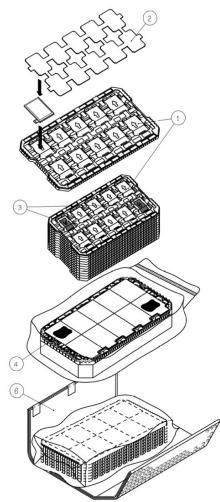
The parameters should be measured after leaving the monitor at the ordinary temperature for 24 hours or more after the test completion.

Item	Standard	Remark
Display quality	No visible abnormality shall be seen.	
	(Except for unevenness by Pol deterioration.)	
Contrast ratio	200 or more	Backlight ON

TOPPAN Original Jig



14. Packing Specifications



- Step 1. Each product is to be placed in one of the cut-outs of the tray with the display surface facing upward.

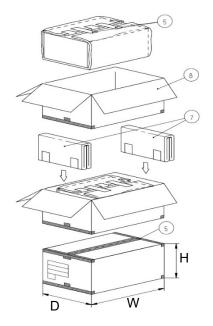
 Foam sheet A are to be placed on the products in the tray.

 (10 products per tray)
- Step 2. Each tray is to be piled up in same orientation and the trays be in a stack of 10.

 One empty tray is to be put on the top of stack of 10 trays.
- Step 3. 2 packs of moisture absorbers are to be placed on the top tray as shown in the drawing.Put piled trays into a sealing bag.
- Step 4. Vacuum and seal the sealing bag with the vacuum sealing machine.
- Step 5. The stack of trays in the plastic back is to be wrapped with B SHEET A.
- Step 6. The wrapped trays are placed in the carton.
- Step 7. B SHEET B are to be inserted into a outer carton with same orientation.

 The outer carton is to be sealed in H-shape with packing tape as shown in the drawing.
- Step 8. The model number, quantity of products, and shipping date are to be printed on the outer carton.

 If necessary, shipping labels or impression markings are to be put on the outer carton.



Remark: The return of packing materials is not required.

Packing item name		Specs., Material	
1	Tray	A-PET	
2	FOAM SHEET	Anti-static polyethylene	
3	Drier	Moisture absorber	
4	Sealing bag		
(5)	Packing tape		
6	B SHEET A	Anti-static air bubble sheet	
7	B SHEET B	Anti-static air bubble sheet	
8	Outer carton	Corrugated cardboard	

Dimension of outer carton		
D : Approx.	(356mm)	
W : Approx.	(664mm)	
H : Approx.	(182mm)	
Quantity of products packed in or	ne carton: 100	
Gross weight : Approx.	6.3 kg	

15. Handling Instruction

15.1 Cautions for Handling LCD panels

Ŵ

Caution

- (1) Do not make an impact on the LCD panel glass because it may break and you may get injured from it.
- (2) If the glass breaks, do not touch it with bare hands.(Fragment of broken glass may stick you or you cut yourself on it.
- (3) If you get injured, receive adequate first aid and consult a medial doctor.
- (4) Do not let liquid crystal get into your mouth. (If the LCD panel glass breaks, try not let liquid crystal get into your mouth even toxic property of liquid crystal has not been confirmed.)
- (5) If liquid crystal adheres, rinse it out thoroughly.
 (If liquid crystal adheres to your cloth or skin, wipe it off with rubbing alcohol or wash it thoroughly with soap.
 If liquid crystal gets into eyes, rinse it with clean water for at least 15 minutes and consult an eye doctor.
- (6) If you scrap this products, follow a disposal standard of industrial waste that is legally valid in the community, country or territory where you reside.
- (7) Do not connect or disconnect this product while its application products is powered on.
- (8) Do not attempt to disassemble or modify this product as it is precision component.
- (9) If a part of soldering part has been exposed, and avoid contact (short-circuit) with a metallic part of the case etc. about FPC of this model, please. Please insulate it with the insulating tape etc. if necessary. The defective operation is caused, and there is a possibility to generation of heat and the ignition.
- (10) Since excess current protection circuit is not built in this TFT module, there is the possibility that LCD module or peripheral circuit become feverish and burned in case abnormal operation is generated. We recommend you to add excess current protection circuit to power supply.
- (11) The devices on the FPC are damageable to electrostatic discharge, because the terminals of the devices are exposed.
 Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors.
 Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.

Caution



This mark is used to indicate a precaution or an instruction which, if not correctly observed, may result in bodily injury, or material damages alone.

15.2 Precautions for Handling

- Wear finger tips at incoming inspection and for handling the TFT monitors to keep display quality and keep the working area clean.
 Do not touch the surface of the monitor as it is easily scratched.
- Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors as the LED in this TFT monitors is damageable to electrostatic discharge.
 Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.
- 3) Avoid strong mechanical shock including knocking, hitting or dropping to the TFT monitors for protecting their glass parts. Do not use the TFT monitors that have been experienced dropping or strong mechanical shock.
- 4) Do not use or storage the TFT monitors at high temperature and high humidity environment.

 Particularly, never use or storage the TFT monitors at a location where condensation builds up.
- 5) Avoid using and storing TFT monitors at a location where they are exposed to direct sunlight or ultraviolet rays to prevent the LCD panels from deterioration by ultraviolet rays.
- Do not stain or damage the contacts of the FPC cable .
 FPC cable needs to be inserted until it can reach to the end of connector slot.
 During insertion, make sure to keep the cable in a horizontal position to avoid an oblique insertion.
 Otherwise, it may cause poor contact or deteriorate reliability of the FPC cable.
- 7) The FPC cable is a design very weak to the bend and the pull as it is fixed with the tape. Do not bend or pull the FPC cable or carry the TFT monitor by holding the FPC cable.
- Peel off the protective film on the TFT monitors during mounting process.
 Refer to the section 15.5 on how to peel off the protective film.
 We are not responsible for electrostatic discharge failures or other defects occur when peeling off the protective film.

15.3 Precautions for Operation

- 1) Since this TFT monitors are not equipped with light shielding for the driver IC, do not expose the driver IC to strong lights during operation as it may cause functional failures.
- 2) In case of powering up or powering off this LCD module, be sure to comply the sequence as instructed in this specification.
- 3) Do not plug in or out the FPC cable while power supply is switch on. Plug the FPC cable in and out while power supply is switched off.
- 4) Do not operate the TFT monitors in the strong magnetic field. It may break the TFT monitors.
- 5) Do not display a fixed image on the screen for a long time. Use a screen-saver or other measures to avoid a fixed image displayed on the screen for a long time. Otherwise, it may cause burn-in image on the screen due the characteristics of liquid crystal.

Issue:Jan.29,2025

15.4 Storage Condition for Shipping Cartons

(Storage environment)

Temperature 0 to 40° C
 Humidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or

wiring materials should be detected.

Time period 1 year

Unpacking
 To prevent damages caused by static electricity, anti-static precautionary measures

(e.g. earthing, anti-static mat) should be implemented. After unpack, keep product in the appropriate condition,

otherwise bubble seal of Protective film may be printed on Polarizer.

Maximum piling up 8 cartons(excluding the bottom)

*Conditions to storage after unpacking

(Storage environment)

Temperature 0 to 40° CHumidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or

wiring materials should be detected.

Time period
 1 year (Shelf life)

Others Keep/ store away from direct sunlight

Storage goods on original tray made by TOPPAN.

15.5 Precautions for Peeling off the Protective film

The followings work environment and work method are recommended to prevent the TFT monitors from static damage or adhesion of dust when peeling off the protective films.

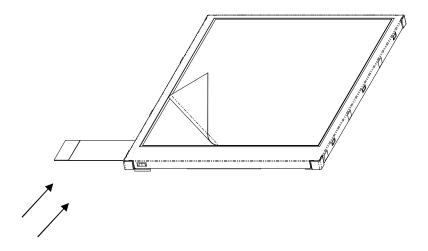
A) Work Environment

- a) Humidity: 50 to 70 %RH, Temperature15 to 27°C
- b) Operators should wear conductive shoes, conductive clothes, conductive finger tips and grounded wrist-straps. Use an electrostatic neutralization blower.
- c) Anti-static treatment should be implemented to work area's floor.
 Use a room shielded against outside dust with sticky floor mat laid at the entrance to eliminate dirt.

B) Work Method

The following procedures should taken to prevent the driver ICs from charging and discharging.

- a) Use an electrostatic neutralization blower to blow air on the TFT monitors to its lower left when FPC is placed at the left.
 Optimize direction of the blowing air and the distance between the TFT monitors and the electrostatic neutralization blower.
- b) Put an adhesive tape (Scotch tape, etc) at the lower left corner area of the protective film to prevent scratch on surface of TFT monitors.
- c) Peel off the adhesive tape slowly (spending more than 2 secs to complete) by pulling it to opposite direction.



Blower wind direction (Set an ion blower with its adequate conditions.)

15.6 Warranty

TOPPAN is only liable to defective goods which is stored and used under the condition complying with this specifications and returned within 1 (one) year.

Warranty caused by manufacturing defect shall be conducted by replacement of goods or refundment at unit price.

APPENDIX

Reference Method for Measuring Optical Characteristics and Performance

1. Measurement Condition

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200(OTSUKA ELECTRONICS), EZcontrastXL88 (ELDIM)

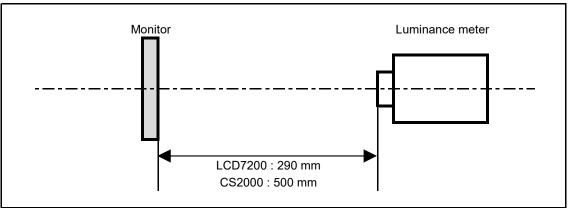
Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified

Measurement system: See the chart below. The luminance meter is placed on the normal line of measurement system.

Measurement point: At the center of the screen unless otherwise specified

Dark box at constant temperature

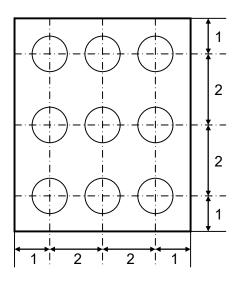


^{*}Measurement is made after 30 minutes of lighting of the backlight.

Measurement point: At the center point of the screen

Brightness distribution: 9 points shown in the following drawing.

<Portrait model>



Dimensional ratio of active area

Backlight IL=6.5mA

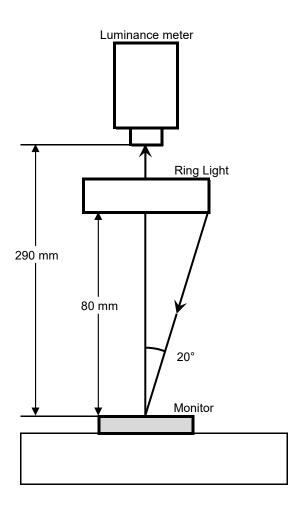
Measurement Condition (Contrast ratio Backlight OFF only)

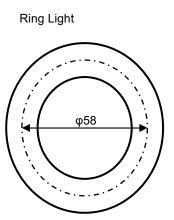
Measuring instruments: LCD7200(OTSUKA ELECTRONICS), Ring Light (40,000 lx, ϕ 58)

Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified Measurement system: See the chart below.

Measurement point: At the center of the screen unless otherwise specified





2. <u>Te</u> st	Method			
Votice	Item	Test method	Measuring instrument	Remark
1	Response time	Measure output signal waveform by the luminance meter when raster of window pattern is changed from white to black and from black to white. Black 100% 90% TOFF	LCD7200	Black display [Data]=00h White display [Data]=3Fh TON Rise time TOFF Fall time
2	Contrast ratio	Measure maximum luminance Y1([Data]=3Fh) and minimum luminance Y2([Data]=00h) at the center of the screen by displaying raster or window pattern. Then calculate the ratio between these two values. Contrast ratio = Y1/Y2 Diameter of measuring point: 7.8mmφ(CS2000) Diameter of measuring point: 3 mmφ(LCD7200)	CS2000 LCD7200	Backlight ON Backlight OFF
3	Viewing angle Horizontalθ Verticalφ	Move the luminance meter from right to left and up and down and determine the angles where contrast ratio is 10.	EZcontrastXL88	
4	White chromaticity	Measure chromaticity coordinates x and y of CIE1931 colorimetric system at [Data] = 3Fh Color matching function: 2°view measurement angle: 1°	CS2000	
5	Center brightness	Measure the brightness at the center of the screen.	CS2000	
6	Brightness distribution	(Brightness distribution) = 100 x B/A % A : max. brightness of the 9 points B : min. brightness of the 9 points	CS2000	
7	Burn-in	Visually check burn-in image on the screen after 2 hours of "window display" ([Data]=00h/3Fh).		At optimized VCOMDC

DATA MODUL

Passion Displayed







All good things come in threes:

With **Hardware**, **Software** and **Services**, we realise unique display solutions that turn your ideas into reality.

www.data-modul.com

